



# CALL FOR PAPERS INTERCON 2024

November 6th - 8th, Lima - Perú

INTERCON (IEEE Peru Section conference) is a renowned IEEE international technical conference which has been conducted in the Peru Section, to bring exciting discoveries, knowledge & understanding together. INTERCON 2024 is the XXXI version of the conference and has been themed inspired by the IEEE Future Directions platforms. Year 2024's INTERCON is co-organized by USIL (Universidad San Ignacio de Loyola) jointly to its IEEE USIL Student Branch. We invite you to submit technical papers for oral presentations. INTERCON 2024 will continue the footsteps of its predecessors, to serve as a great platform for researchers to discuss and explore advanced technologies in advancing humanity.

## Topics (but not limited to):

- T1. Artificial Intelligence and Machine learning
- T2. Communications and Networking
- T3. Power, Energy, and Power Electronics
- T4. Biomedical Engineering & Healthcare Technologies
- T5. Robotics, Control, Instrumentation, and Automation
- T6. Multimedia Signal Processing and Analytics
- T7. Devices, Circuits, and Materials
- T8. RF Circuits, Systems, and Antennas
- T9. Data Science and Computing Technologies
- T10. Education in Engineering and Technology

## Important Dates - Regular Track

**Deadline paper submission:** June 2nd, 2024  
**Notification of Acceptance:** September 1st, 2024  
**Camera Ready Submission:** September 29th, 2024  
**Author Registration:** October 6th, 2024  
**Conference date:** November 6th - 8th, 2024

## Organizing Committee

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## Submission:

The conference invites research papers of varying length from 6 to 8 pages (including abstract and references) and written in English. The format of the papers is based on IEEE conference template, which can be downloaded from:

<https://www.ieee.org/conferences/publishing/templates.htm>

For all accepted papers, the authors will be asked to sign a copyright transfer on the contents of their paper(s). The accepted papers will be indexed and published on the IEEE Xplore digital library

All papers, only in PDF file, must be submitted electronically through the EasyChair:

<https://easychair.org/conferences/?conf=2024ieeeintercon>

